

**CTLSH05-4M521**  
**SURFACE MOUNT**  
**LOW  $V_F$**   
**SILICON SCHOTTKY DIODE**



**TLM521 CASE**

**MARKING CODE: CA**

**central™**  
**Semiconductor Corp.**

**DESCRIPTION:**

The CENTRAL SEMICONDUCTOR CTLH05-4M521 Low  $V_F$  Schottky Diode is a high quality Schottky Diode designed for applications where small size and operational efficiency are the prime requirements. With a maximum power dissipation of 0.9W, and a very small package footprint (comparable to the SOT-563), this leadless package design is capable of dissipating over 3 times the power of similar devices in comparable sized surface mount packages.

**FEATURES:**

- Very Small Package Size
- Current ( $I_F=0.5A$ )
- Low Forward Voltage Drop ( $V_F=0.47V$  MAX @ 0.5A)
- High Thermal Efficiency
- Small TLM 2x1mm case

**APPLICATIONS:**

- DC/DC Converters
- Voltage Clamping
- Protection Circuits
- Battery Powered Portable Equipment

**MAXIMUM RATINGS:** ( $T_A=25^\circ C$ )

	<b>SYMBOL</b>		<b>UNITS</b>
Peak Repetitive Reverse Voltage	$V_{RRM}$	40	V
Continuous Forward Current	$I_F$	500	mA
Peak Repetitive Forward Current, $t_p \leq 1\text{ms}$	$I_{FRM}$	3.5	A
Forward Surge Current, $t_p=8\text{ms}$	$I_{FSM}$	10	A
Power Dissipation	$P_D$	0.9	W*
Operating and Storage			
Junction Temperature	$T_J, T_{stg}$	-65 to +150	°C
Thermal Resistance	$\Theta_{JA}$	139	°C/W*

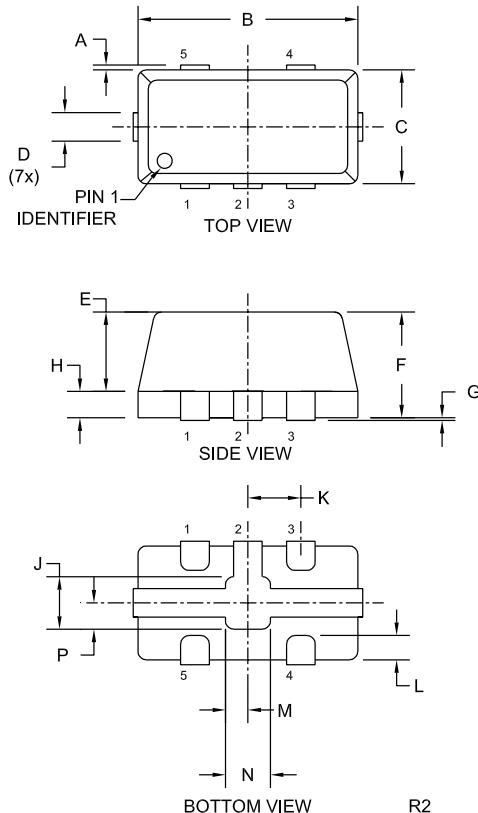
**ELECTRICAL CHARACTERISTICS:** ( $T_A=25^\circ C$  unless otherwise noted)

<b>SYMBOL</b>	<b>TEST CONDITIONS</b>	<b>MIN</b>	<b>MAX</b>	<b>UNITS</b>
$I_R$	$V_R= 10V$		20	$\mu A$
$I_R$	$V_R= 30V$		100	$\mu A$
$BV_R$	$I_R= 500\mu A$	40		V
$V_F$	$I_F= 100\mu A$		0.13	V
$V_F$	$I_F= 1.0mA$		0.21	V
$V_F$	$I_F= 10mA$		0.27	V
$V_F$	$I_F= 100mA$		0.35	V
$V_F$	$I_F= 500mA$		0.47	V
$C_T$	$V_R=1.0V, f=1.0MHz$	50		pF

\*FR-4 Epoxy PCB with copper mounting pad area of 33mm<sup>2</sup>

R1 (27-April 2006)

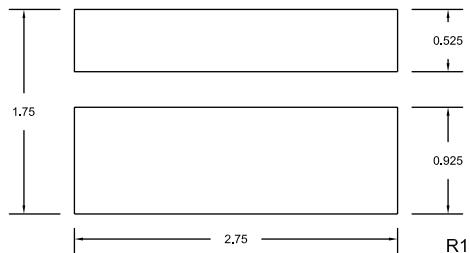
TLM521 CASE - MECHANICAL OUTLINE



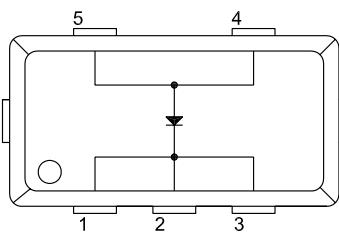
SYMBOL	DIMENSIONS		INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX	MIN	MAX
A	—	—	0.005	—	—	0.125
B	0.075	—	0.083	1.900	2.100	—
C	0.035	—	0.043	0.900	1.100	—
D	0.007	—	0.012	0.170	0.300	—
E	0.026	—	0.030	0.650	0.750	—
F	0.031	—	0.039	0.800	1.000	—
G	0.000	—	0.002	0.000	0.050	—
H	0.006	—	0.010	0.150	0.250	—
J	0.013	—	0.021	0.330	0.530	—
K	—	0.020	—	0.500	—	—
L	0.004	—	0.014	0.100	0.350	—
M	0.002	—	0.010	0.060	0.260	—
N	0.009	—	0.017	0.220	0.420	—
P	0.005	—	0.013	0.120	0.320	—

TLM521 (REV: R2)

Suggested mounting pad layout  
for maximum power dissipation  
(Dimensions in mm)



For standard mounting refer  
to TLM521 Package Details



**LEAD CODE:**

- 1) CATHODE
- 2) CATHODE
- 3) CATHODE
- 4) ANODE
- 5) ANODE

**MARKING CODE: CA**

R1 (27-April 2006)